Instrumentation for sub-mm astronomy

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Introduction







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Astronomy at sub-mm wavelengths

Between infrared and millimetre No strict definition: usually from \sim 200 µm to \sim few mm







CSO and JCMT, Mauna Kea, Hawaii

Why do sub-mm astronomy? Sicince & Technology Facilities Council UK Astronomy Technology Centre

It lets us see cold things - peak in a 10 K blackbody is at 300 μm

Cold things are interesting: usually objects in formation (galaxies, stars, planets...)

• Sub-mm emission usually "optically thin"; so we see the interior rather than just the surface of objects



Example: sub-mm (850 µm) contours overlaid (SCUBA)









Dominant detector type for photometry (as opposed to spectroscopy) is the bolometer







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Semiconductor bolometers



The first bolometer



Bolometer invented by S. P. Langley in 1880 for infra-red astronomy (and luminous insects)







81 years later, F. Low developed the cryogenic (4 K) bolometer using doped germanium as the thermistor

Low temperature operation:

- Reduces blackbody background radiation
- Increases sensitivity:
 - heat capacity is reduced
 - doped semiconductors can have very large dR/dT

The original application was not astronomy, but soon adopted (along with the inventor) for IR astronomy









Now replaced by photodetectors in IR, but the detector of choice for photometry in the sub-mm:































To get sufficiently good performance, operate at 300 mK or lower

- Makes instruments complex (and expensive)
- Much lower than needed in most areas of astronomy









Bolometers are broad-band devices: they respond equally to all absorbed wavelengths

- Have to filter out unwanted wavelengths
- Metal mesh filters can be produced with precisely defined bandpasses









For high resolution spectroscopy, astronomers use coherent (heterodyne) systems, as in radio astronomy

- Outside the scope of this review
- Also operate at low temperatures and challenging to build







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Unlike at optical and infra-red wavelengths, historically few commercial and military applications in sub-mm

Development largely in universities and government labs rather than industry

Cost \$2000/pixel c.f. \$0.12 for infrared, \$0.01 for optical









Composite bolometers introduced in 1970s

- Reducing thermal conductance increases sensitivity
- But also increases time constant
- Reduce again by reducing heat capacity
- This is the main reason for such low temperatures
- Composite bolometer reduces heat capacity further by separating absorber and thermometer



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Early instruments contained a single pixel





UKT14 (ROE, Edinburgh)





Bolometer arrays



Arrays appeared in the 1980's, making better use of telescopes



SCUBA (ROE, Edinburgh)





SCUBA



Largest of the early arrays

- 131 pixels
- Composite bolometers (sapphire substrate, brass wire thermal link)
- Hand assembled from individual pixels
- Arrays (and in particular SCUBA) revolutionised the field







SCUBA individual pixel







NTD germanium



Sensitive and uniform behaviour requires uniform doping

- SCUBA and other modern germanium bolometers use Neutron Transmutation Doping (NTD)
- Converts ⁷⁰Ge to ⁷¹Ga (acceptor) and 74Ge to 75As (donor)
- Since germanium isotopes are uniformly distributed, result is uniform doping and simple behaviour





Early instruments





1997-



Number of pixels

.3K Operating temperature







Modern bolometers built by micromachining

- Silicon nitride deposited on silicon wafer
- Silicon etched to form SiN membranes
- Form absorber and supports
- Metallisation defines absorber and weak thermal link
- "Spiderweb" shape reduces heat capacity and exposure to ionizing radiation



Beryllium copper heat sink



JPL spiderweb bolometers





Either break out into individual detectors, or leave to form an array



HFI bolometers (JPL/Cardiff)



Spiderweb array wafer (JPL)

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But still have to stick germanium chips individually on each pixel





Alternative: make thermistors from the silicon itself by ion implantation

• Initial problems with excess noise, but recently discovered it could be removed by using thicker implants



SHARC-II (GSFC/Caltech)







Difficult to multiplex germanium or silicon bolometers without introducing too much noise

Limits array sizes

 "CCD-like" CMOS multiplexed silicon arrays have been produced using very high thermistor resistances to increase signals to partially overcome multiplexer noise



Figure 4: schematic drawing of the PACS bolometer array





Facility instruments on telescopes now

Telescope	Instrument	Wavelength(s)	Pixels	s Technology	Temperature	Status
APEX	LABOCA	870 μm	295	NTD Ge	300 mK	
ASTE	AzTEC	1.1 or 2.1 $\mu {\rm m}$	144	NTD Ge	$300 \mathrm{mK}$	
CSO	SHARC-II	350, 450 or 850 $\mu {\rm m}$	384	Ion implanted Si	300 mK	
CSO	$\operatorname{Bolocam}$	1.1 or 2.1 mm	119	NTD Ge	300 mK	
GBT	MUSTANG	3 mm	64	TES	300 mK	In commissioning
Herschel	PACS	60 - 210 $\mu {\rm m}$	2560	Ion implanted Si	300 mK	Awaiting launch (2009)
Herschel	SPIRE	200 - 670 $\mu{\rm m}$	326	NTD Ge	$300 \ \mathrm{mK}$	Awaiting launch (2009)
IRAM 30 m	MAMBO-2	1.2 mm	117	NTD Ge	300 mK	
JCMT	SCUBA-2	450 and 850 $\mu\mathrm{m}$	10240	TES	100 mK	In commissioning

Doesn't include dedicated PI instruments or CMB instruments



NTD germanium arrays



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AzTEC (JPL) 144 pixels



LABOCA (MPIfR) 295 pixels







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Silicon arrays





SHARC-II (GSFC/Caltech) 384 pixels

PACS arrays (CEA/LETI) 2560 pixels











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Superconducting bolometers



Superconducting bolometers Science & Technology Facilities Council UK Astronomy Technology Centre

Even without multiplexing, fundamental noise limits reached Solution: superconductors (transition edge sensor; TES)

- Very large dR/dT at transition
- But have to keep on transition
- Key to use in astronomy was realisation (K. Irwin, 1995) that voltage bias keeps them automatically on transition



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Superconducting bolometers (UK Astronomy Technology Centre

Has taken \sim 10 years to find and eliminate excess noise sources to make TES arrays practical

Advantages:

- Low fundamental noise limits
- Can be constructed on an array scale by thin-film deposition and lithography
- Can be multiplexed with minimal noise penalty by superconducting electronics

New generation of instruments using TES arrays now in construction and on telescopes



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SCUBA-2



- Eight arrays; 1280 pixels each
- Constructed from detector and multiplexer silicon wafer, indium bump bonded together like an infrared array



SCUBA-2 sub-array (SCUBA array inset)









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Somewhat bigger than predecessors





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Facility instruments



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SCUBA-2 (1280 pixels installed here)





(64 pixels)





Other arrays



Other arrays already on telescope dedicated to CMB work



APEX-SZ 55 x 6 pixels (on telescope)

And many more to come...



MBAC 1024 pixels (on telescope)





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- Multiplexer fabrication is complex, especially for large arrays
- Increasing array sizes further will be very difficult
- Too much power sends detector above transition; no response
 - Worrying for a space mission where background unknown, and can't fix problems
 - Semiconductor bolometers work in high background with reduced sensitivity





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The future



KIDs



Alternative technology: Kinetic Inductance Device

- Use superconductor below transition
- Radiation breaks Cooper pairs
 - like electron-hole pair creation in semiconductor, but with smaller energy gap
- Detect by change in AC inductance
- Advantage: can read out many devices with single coax
 - Simple detector fabrication
 - No complex multiplexer to make
- Still need ultra low temperatures though
- Looks very promising



Prototype KID camera (Caltech/JPL)





STJS



Superconducting tunnel junctions use similar principle

- Pair breaking detected by current flowing through tunnel junction which blocks Cooper pairs
- Like semiconductor photoconductor
- BUT: currently no practical way to multiplex



STJ array (ESTEC/ESA)







Hot-spot superconducting detectors





Antenna coupling



Another area being developed is antenna coupled detectors

- Radiation detected by planar antenna
- Transmitted to detector by waveguide
- Can filter wavelengths *electrically* rather than optically
- One antenna can feed several pixels for different wavelengths







X and gamma detection



All these technologies can also be used to detect X and gamma rays

- Detect energy pulse from individual photons
- Therefore have energy/wavelength resolution
- Appealing for X-ray astronomy (and industrial applications)
 - High resolution and efficiency justify complication of cooling to under 100 mK
- Useful since can share development with sub-mm community



Optical/IR

Nebula



They can even be operated at optical/IR wavelengths

- Detect heat from absorption of single photon, and use to determine wavelength!
- Unique combination of spatial and spectral measurement along with accurate timing information
 Used to measure rapidly varying spectrum e.g. Crab

Optical TES array (Stanford)







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Conclusions





The next few years will be very interesting:

- Many new instruments coming on line
- Not clear which technologies will dominate for the next generation of instruments

One current goal is to produce detectors for a space mission with a cold (5 K) mirror

- Will have to be considerably more sensitive than current detectors
- Different groups developing TES, KID, CMOS multiplexed silicon arrays and many more...





The End







